

Flangeless Mount Termination 200 Watts, 50Ω

Description



The E200N50X4 is high performance Aluminum Nitride (AlN) termination intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators and for use in power combiners. The termination is also RoHS compliant!

General Specifications

Resistive Element	Thick film
Substrate	AlN Ceramic
Terminal Finish	Matte Tin over Nickel Barrier
Operating Temperature	-50 to +200°C (see de rating chart)

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. **All dimensions in inches.**

Electrical Specifications

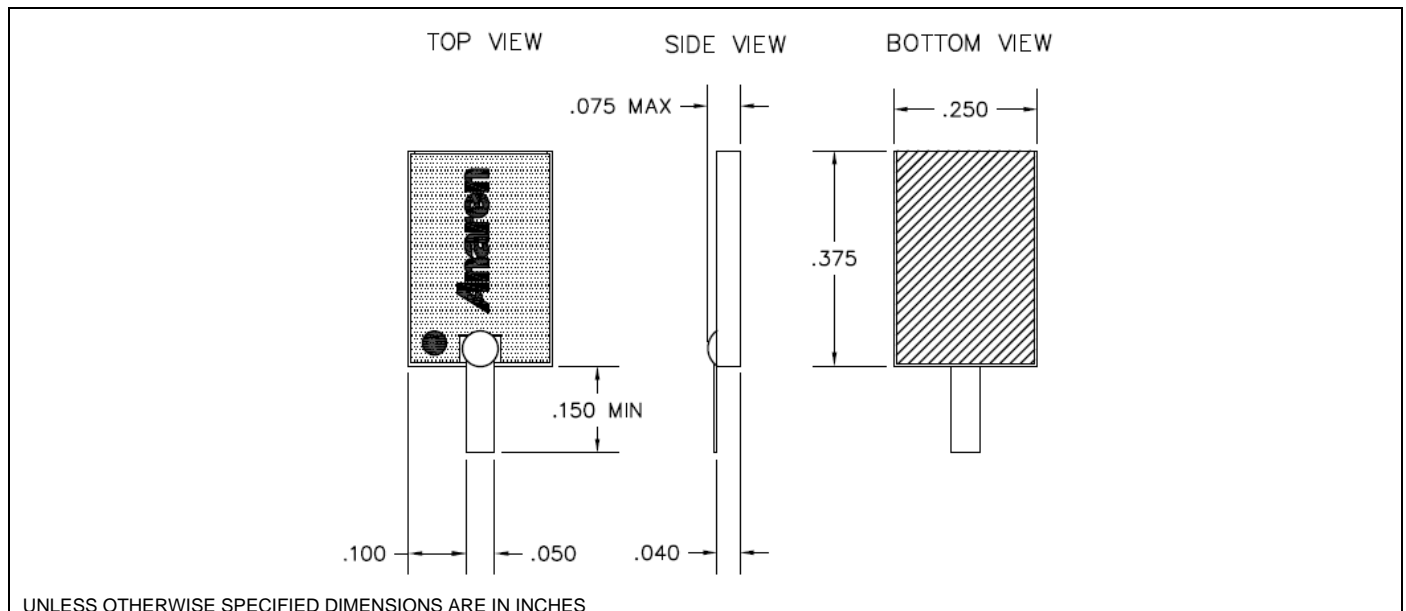
Resistance Value:	50 Ohms, $\pm 2\%$
Power:	200 Watts
Frequency Range:	DC – 2.2 GHz
Return Loss	> 20 dB DC – 2.2 GHz

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

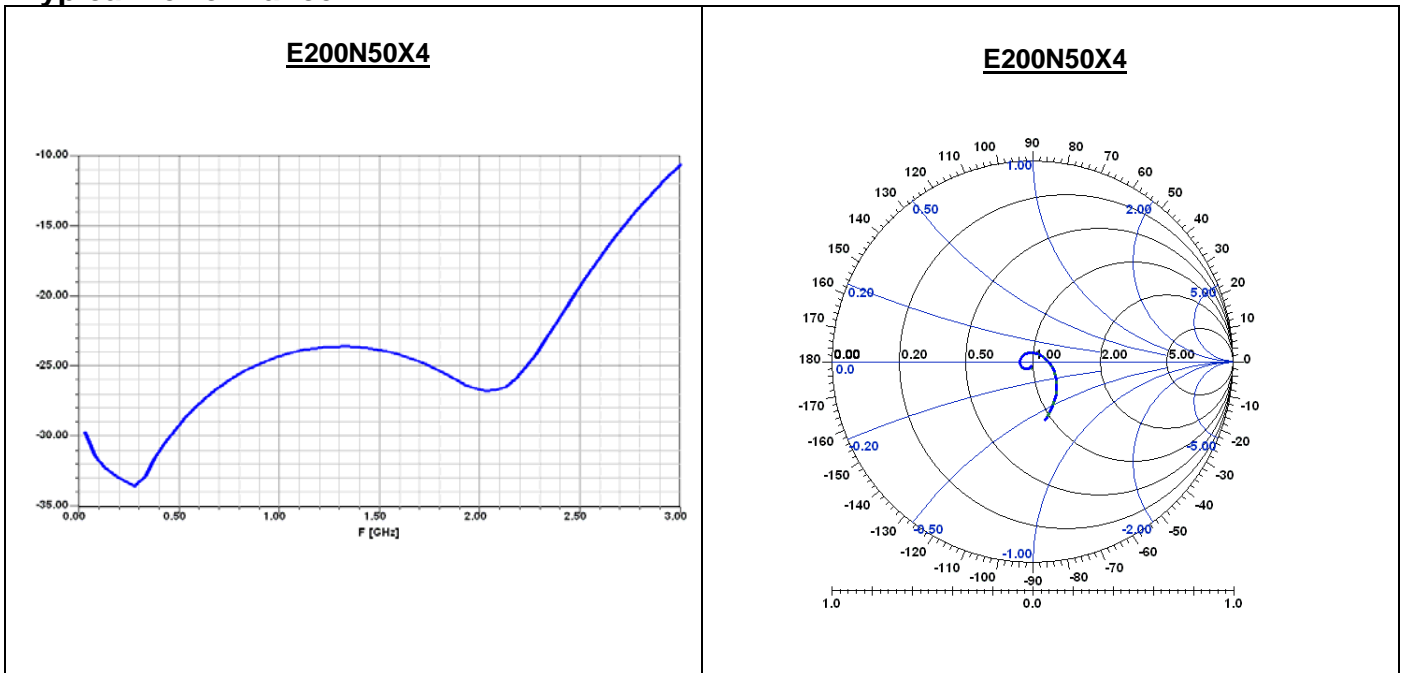
Features:

- RoHS Compliant
- 200 Watts
- DC – 2.2GHz
- AlN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

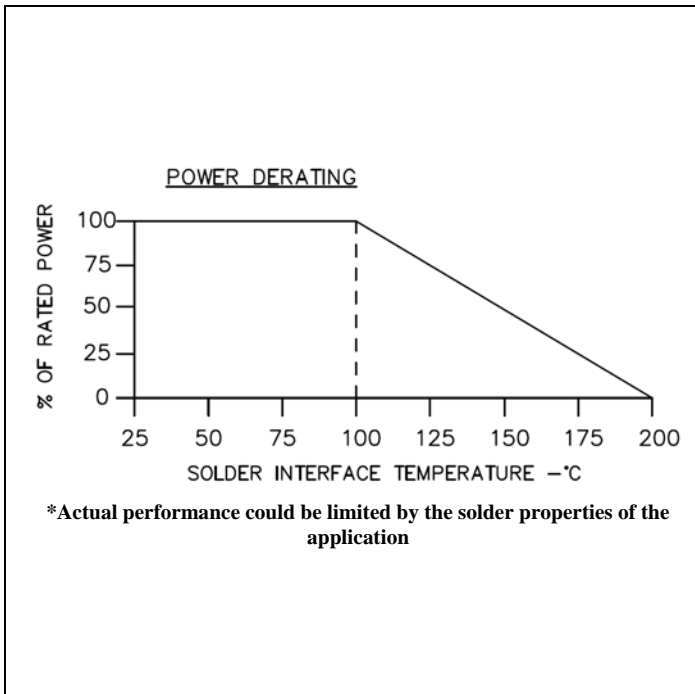
Outline Drawing



Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:

The diagrams show two mounting scenarios. The left scenario, labeled 'SUGGESTED STRESS RELIEF METHODS', shows a component on a board with a 0.025 inch gap between the board and the component leads. This is further divided into 'BOARD LOWER THAN LEAD' and 'BOARD EVEN WITH LEAD'. The right scenario, labeled 'NOT RECOMMENDED APPLICATION', shows a component on a board where the board is either lower or higher than the leads. Both diagrams are at a scale of 'NONE'.

SUGGESTED MOUNTING PROCEDURE

1. MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
2. POSITION DEVICE ON MOUNTING SURFACE AND SOLDER IN PLACE USING AN APPROPRIATE SOLDER.
3. SOLDER LEADS IN PLACE USING AN APPROPRIATE SOLDER TYPE WITH A CONTROLLED TEMPERATURE IRON.